## Product Summary

| BVDSS | RDS(ON) Max | ID Max <br> $\mathbf{T}_{A}=+25^{\circ} \mathrm{C}$ |
| :---: | :---: | :---: |
| 50 V | $3.5 \Omega @ V_{G S}=10 \mathrm{~V}$ | 200 mA |

## Description

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

## Applications

- Load switches


## Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free \& Fully RoHS Compliant (Notes 1 \& 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The BSS138DWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.
https://www.diodes.com/quality/product-definitions/


## Mechanical Data

- Package: SOT363
- Package Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208e3
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)


Top View


Top View Internal Schematic

## Ordering Information (Note 4)

| Part Number | Package | Packing |  |
| :---: | :---: | :---: | :---: |
|  | Qty. | Carrier |  |
| BSS138DWQ-7 | SOT363 | 3,000 | Tape \& Reel |
| BSS138DWQ-13 | SOT363 | 10,000 | Tape \& Reel |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) \& 2015/863/EU (RoHS 3) compliant.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain $<900 \mathrm{ppm}$ bromine, $<900 \mathrm{ppm}$ chlorine ( $<1500 \mathrm{ppm}$ total $\mathrm{Br}+\mathrm{Cl}$ ) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## Marking Information



BSS138DWQ

Maximum Ratings $@ T_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic | Symbol | BSS138DW | Unit |
| :--- | :---: | :---: | :---: |
| Drain-Source Voltage | VDSS | 50 | V |
| Drain-Gate Voltage (Note 7) | VDGR | 50 | V |
| Gate-Source Voltage | VGSS | $\pm 20$ | V |
| Drain Current (Note 5) | Continuous | Continuous | 200 |

Thermal Characteristics (@T $A=+25^{\circ} \mathrm{C}$, unless othemise specified.)

| Characteristic | Symbol | BSS138DW | Unit |
| :---: | :---: | :---: | :---: |
| Total Power Dissipation (Note 5) | PD | 200 | mW |
| Thermal Resistance, Junction to Ambient | R ${ }_{\text {®JA }}$ | 625 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating and Storage Temperature Range | TJ, Tsta | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

## Electrical Characteristics (@TA $=+25^{\circ} \mathrm{C}$, unless otherwise speified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS (Note 6) |  |  |  |  |  |  |
| Drain-Source Breakdown Voltage | BV ${ }_{\text {DSS }}$ | 50 | 75 | - | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{ld}=250 \mu \mathrm{~A}$ |
| Zero Gate Voltage Drain Current | Idss | - | - | 0.5 | $\mu \mathrm{A}$ | V DS $=50 \mathrm{~V}, \mathrm{VGS}=0 \mathrm{~V}$ |
| Gate-Body Leakage | Igss | - | - | $\pm 100$ | nA | VGS $= \pm 20 \mathrm{~V}, \mathrm{VDS}=0 \mathrm{~V}$ |
| ON CHARACTERISTICS (Note 6) |  |  |  |  |  |  |
| Gate Threshold Voltage | $\mathrm{VGS}(\mathrm{TH})$ | 0.5 | 1.2 | 1.5 | V | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{ld}=250 \mu \mathrm{~A}$ |
| Static Drain-Source On-Resistance | $\mathrm{RDS}(\mathrm{ON})$ | - | 1.4 | 3.5 | $\Omega$ | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{ID}=0.22 \mathrm{~A}$ |
| Forward Transconductance | gFs | 100 | - | - | mS | $V_{D S}=25 \mathrm{~V}, \mathrm{ld}=0.2 \mathrm{~A}, \mathrm{f}=1.0 \mathrm{kHz}$ |
| DYNAMIC CHARACTERISTICS |  |  |  |  |  |  |
| Input Capacitance | Ciss | - | - | 50 | pF | V DS $=10 \mathrm{~V}, \mathrm{VGS}=0 \mathrm{~V}, \mathrm{f}=1.0 \mathrm{MHz}$ |
| Output Capacitance | Coss | - | - | 25 | pF |  |
| Reverse Transfer Capacitance | Crss | - | - | 8.0 | pF |  |
| SWITCHING CHARACTERISTICS |  |  |  |  |  |  |
| Turn-On Delay Time | tD(ON) | - | - | 20 | ns | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=30 \mathrm{~V}, \mathrm{ID}=0.2 \mathrm{~A}, \\ & \mathrm{R}_{\mathrm{GEN}}=50 \Omega \end{aligned}$ |
| Turn-Off Delay Time | tD(OFF) | - | - | 20 | ns |  |

Notes: 5. Device mounted on FR-4 PCB, 1 inch $\times 0.85$ inch $\times 0.062$ inch; pad layout as shown at http://www.diodes.com/package-outlines.html.
6. Short duration pulse test used to minimize self-heating effect.
7. $R G s \leqslant 20 \mathrm{k} \Omega$.

BSS138DWQ


Fig. 1 Drain-Source Current vs. Drain-Source Voltage


Fig. 3 Drain-Source On Resistance vs. Junction Temperature


Fig. 5 Drain-Source On-Resistance vs. Drain-Current


Fig. 2 Transfer Characteristics


Fig. 4 Gate Threshold Voltage vs. Junction Temperature


Fig. 6 Drain-Source On-Resistance vs. Drain-Current


Fig. 7 Drain-Source On-Resistance vs. Drain-Current


Fig. 9 Body Diode Current vs. Body Diode Voltage


Fig. 8 Drain-Source On-Resistance vs. Drain-Current


Fig. 10 Capacitance vs. Drain-Source Voltage

BSS138DWQ

## Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.
SOT363


| SOT363 |  |  |  |
| :---: | :---: | :---: | :---: |
| Dim | Min | Max | Typ |
| A1 | 0.00 | 0.10 | 0.05 |
| A2 | 0.90 | 1.00 | 0.95 |
| b | 0.10 | 0.30 | 0.25 |
| c | 0.10 | 0.22 | 0.11 |
| D | 1.80 | 2.20 | 2.15 |
| E | 2.00 | 2.20 | 2.10 |
| E1 | 1.15 | 1.35 | 1.30 |
| $\mathbf{e}$ | 0.650 BSC |  |  |
| F | 0.40 | 0.45 | 0.425 |
| L | 0.25 | 0.40 | 0.30 |
| $\mathbf{a}$ | $0^{\circ}$ | $8^{\circ}$ | -- |
| All Dimensions in $\mathbf{~ m m}$ |  |  |  |

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.


| Dimensions | Value <br> (in mm) |
| :---: | :---: |
| $\mathbf{C}$ | 0.650 |
| $\mathbf{G}$ | 1.300 |
| $\mathbf{X}$ | 0.420 |
| $\mathbf{Y}$ | 0.600 |
| $\mathbf{Y 1}$ | 2.500 |

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